BC857BTT1G

General Purpose Transistor

PNP Silicon

These transistors are designed for general purpose amplifier applications. They are housed in the SOT−416/SC−75 which is designed for low power surface mount applications.

Features

- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC−Q101 Qualified and PPAP Capable
- This is a Pb−Free Device

MAXIMUM RATINGS (T_A = 25°C)

Rating	Symbol	Max	Unit
Collector−Emitter Voltage	V_{CEO}	−45	V
Collector−Base Voltage	V_{CBO}	−50	V
Emitter−Base Voltage	V_{EBO}	−5.0	V
Collector Current – Continuous	I_C	−100	mAdc
Collector Current – Peak	I_C	−200	mAdc

THERMAL CHARACTERISTICS

| Characteristic	Symbol	Max	Unit
Total Device Dissipation, FR−4 Board (Note 1) T_A = 25°C Derated above 25°C	P_D	200 1.6	mW mW/°C
Thermal Resistance, Junction−to−Ambient (Note 1)	$R_{\theta JA}$	600	°C/W
Total Device Dissipation, FR−4 Board (Note 2) T_A = 25°C Derated above 25°C	P_D	300 2.4	mW mW/°C
Thermal Resistance, Junction−to−Ambient (Note 2)	$R_{\theta JA}$	400	°C/W
Junction and Storage Temperature Range	T_J, T_{stg}	−55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
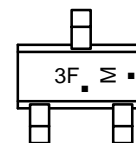
1. FR−4 @ min pad.
2. FR−4 @ 1.0×1.0 in pad.

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COLLECTOR
3

1
BASE

2
EMITTER
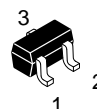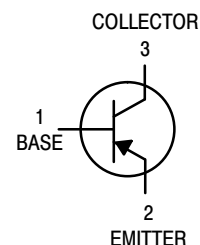
CASE 463
SOT−416
STYLE 1

MARKING DIAGRAM

3F = Device Code
M = Date Code
▪ = Pb−Free Package

(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

BC857BTT1G

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector – Emitter Breakdown Voltage (I_C = –10 mA)	$V_{(BR)CEO}$	–45	–	–	V
Collector – Emitter Breakdown Voltage (I_C = –10 μA, V_{EB} = 0)	$V_{(BR)CES}$	–50	–	–	V
Collector – Base Breakdown Voltage (I_C = –10 μA)	$V_{(BR)CBO}$	–50	–	–	V
Emitter – Base Breakdown Voltage (I_E = –1.0 μA)	$V_{(BR)EBO}$	–5.0	–	–	V
Collector Cutoff Current (V_{CB} = –30 V) (V_{CB} = –30 V, T_A = 150°C)	I_{CBO}	– –	– –	–15 –4.0	nA μA
ON CHARACTERISTICS					
DC Current Gain (I_C = –10 μA, V_{CE} = –5.0 V) (I_C = –2.0 mA, V_{CE} = –5.0 V)	h_{FE}	– 220	150 290	– 475	–
Collector – Emitter Saturation Voltage (I_C = –10 mA, I_B = –0.5 mA) (I_C = –100 mA, I_B = –5.0 mA)	$V_{CE(sat)}$	– –	– –	–0.3 –0.65	V
Base – Emitter Saturation Voltage (I_C = –10 mA, I_B = –0.5 mA) (I_C = –100 mA, I_B = –5.0 mA)	$V_{BE(sat)}$	– –	–0.7 –0.9	– –	V
Base – Emitter On Voltage (I_C = –2.0 mA, V_{CE} = –5.0 V) (I_C = –10 mA, V_{CE} = –5.0 V)	$V_{BE(on)}$	–0.6 –	– –	–0.75 –0.82	V
SMALL – SIGNAL CHARACTERISTICS					
Current – Gain – Bandwidth Product (I_C = –10 mA, V_{CE} = –5.0 Vdc, f = 100 MHz)	f_T	100	–	–	MHz
Output Capacitance (V_{CB} = –10 V, f = 1.0 MHz)	C_{ob}	–	–	4.5	pF
Noise Figure (I_C = –0.2 mA, V_{CE} = –5.0 Vdc, R_S = 2.0 kΩ, f = 1.0 kHz, BW = 200 Hz)	NF	–	–	10	dB

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
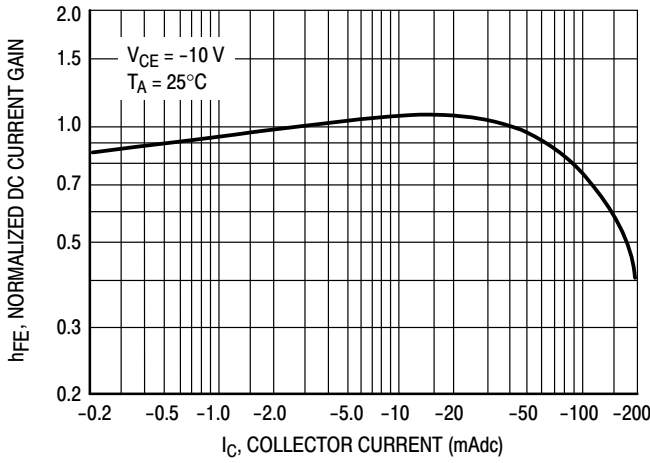
BC857BTT1G

TYPICAL CHARACTERISTICS
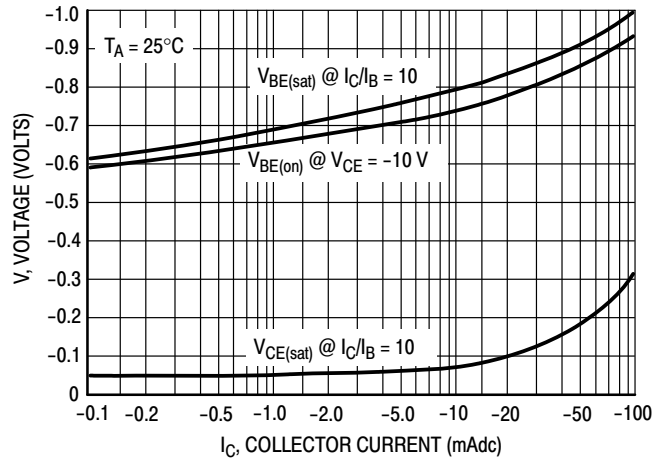

Figure 1. Normalized DC Current Gain
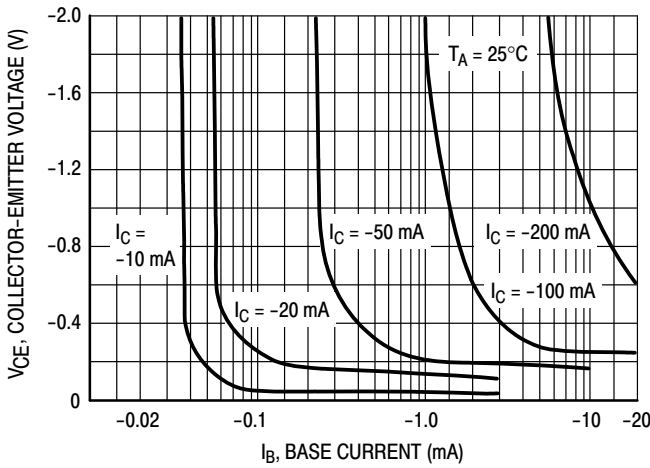

Figure 2. "Saturation" and "On" Voltages

Figure 3. Collector Saturation Region

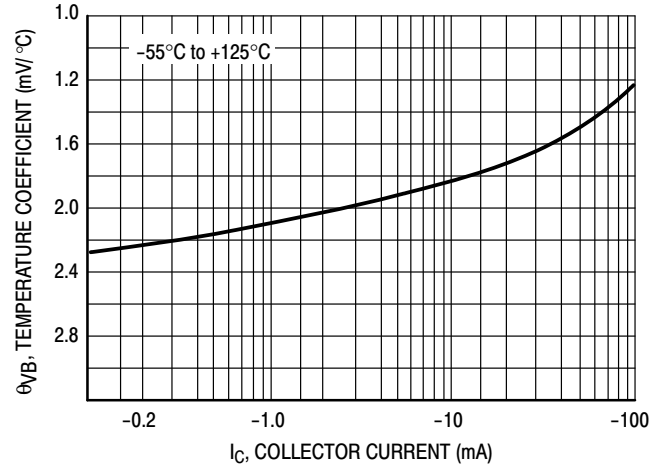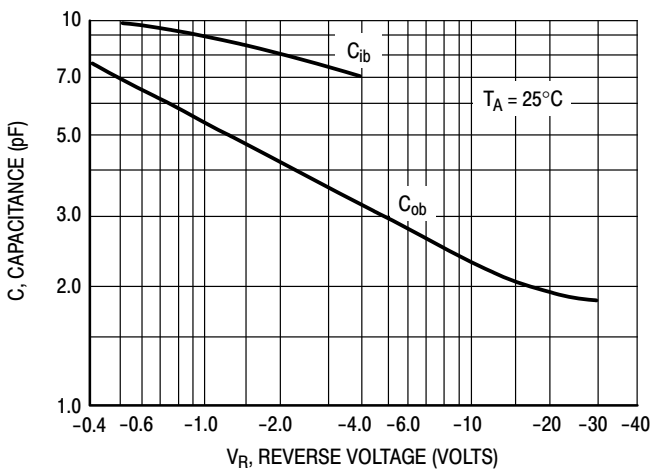**Figure 4. Base–Emitter Temperature Coefficient**
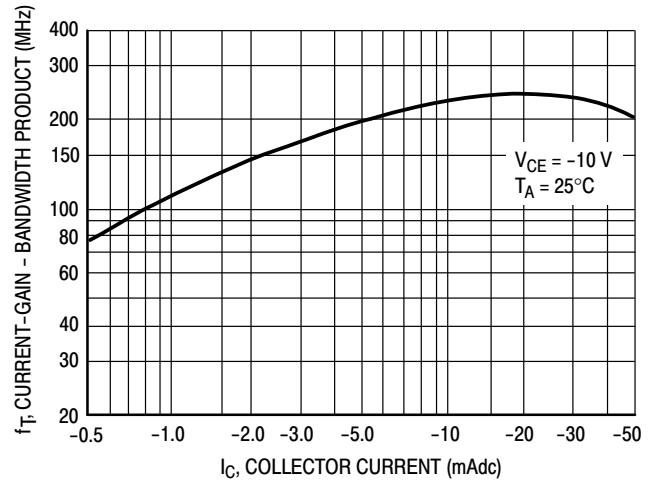

Figure 5. Capacitances
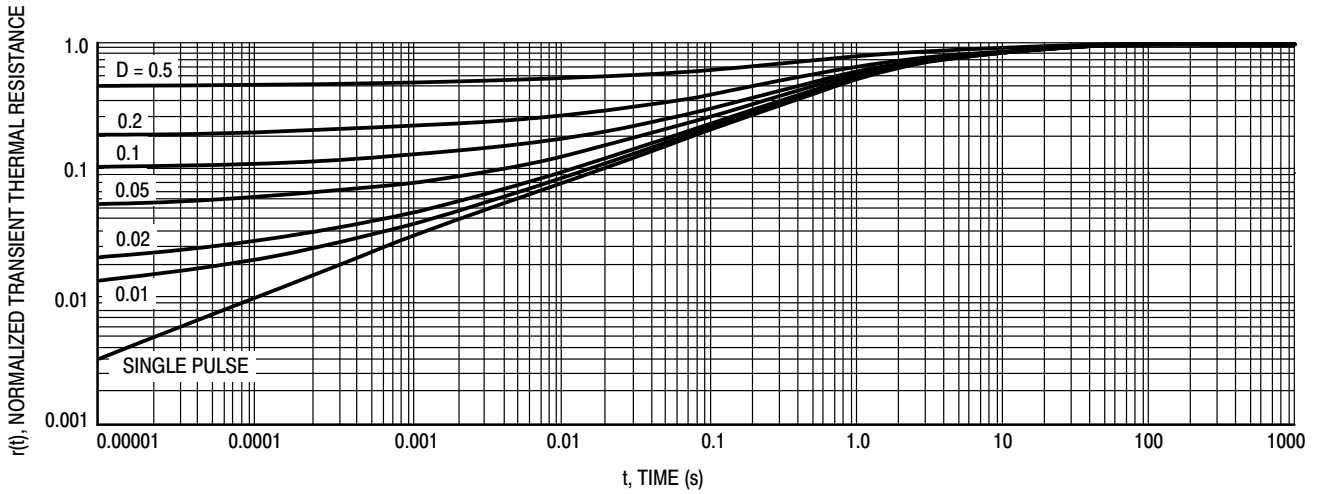

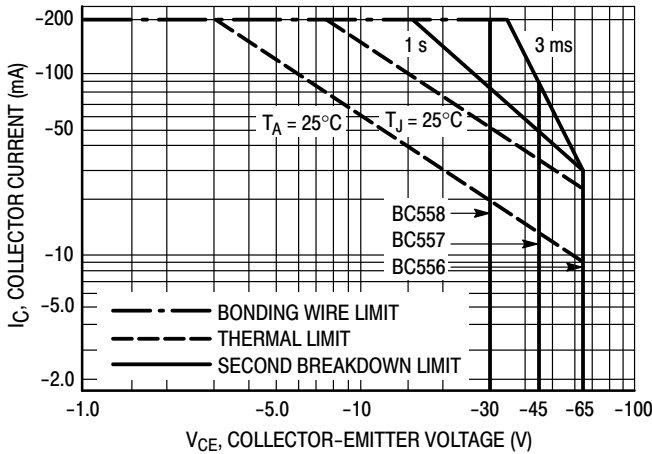**Figure 6. Current–Gain – Bandwidth Product**

Figure 7. Thermal Response

Figure 8. Active Region Safe Operating Area

The safe operating area curves indicate I_C–V_{CE} limits of the transistor that must be observed for reliable operation. Collector load lines for specific circuits must fall below the limits indicated by the applicable curve.

The data of Figure 8 is based upon $T_{J(pk)} = 150°C$; T_C or T_A is variable depending upon conditions. Pulse curves are valid for duty cycles to 10% provided $T_{J(pk)} \leq 150°C$. $T_{J(pk)}$ may be calculated from the data in Figure 7. At high case or ambient temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by the secondary breakdown.

ORDERING INFORMATION

Device	Package	Shipping†
BC857BTT1G	SOT–416 (PB–Free)	3,000 / Tape & Reel
NSVBC857BTT1G*		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable.
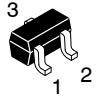
SC−75/SOT−416
CASE 463−01
ISSUE G

DATE 07 AUG 2015

SCALE 4:1

NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.70	0.80	0.90	0.027	0.031	0.035
A1	0.00	0.05	0.10	0.000	0.002	0.004
b	0.15	0.20	0.30	0.006	0.008	0.012
C	0.10	0.15	0.25	0.004	0.006	0.010
D	1.55	1.60	1.65	0.061	0.063	0.065
E	0.70	0.80	0.90	0.027	0.031	0.035
e	1.00 BSC			0.04 BSC		
L	0.10	0.15	0.20	0.004	0.006	0.008
H_E	1.50	1.60	1.70	0.060	0.063	0.067

STYLE 1:
PIN 1. BASE
2. EMITTER
3. COLLECTOR

STYLE 2:
PIN 1. ANODE
2. N/C
3. CATHODE

STYLE 3:
PIN 1. ANODE
2. ANODE
3. CATHODE

STYLE 4:
PIN 1. CATHODE
2. CATHODE
3. ANODE

STYLE 5:
PIN 1. GATE
2. SOURCE
3. DRAIN

GENERIC
MARKING DIAGRAM*
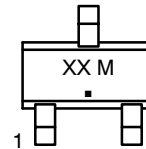
XX   = Specific Device Code
M   = Date Code
▪   = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, "G" or microdot " ▪", may or may not be present.

SOLDERING FOOTPRINT*
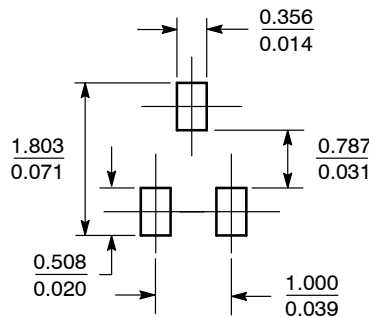
SCALE 10:1   ($\frac{mm}{inches}$)

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	SC−75/SOT−416		PAGE 1 OF 1

ADDITIONAL INFORMATION

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